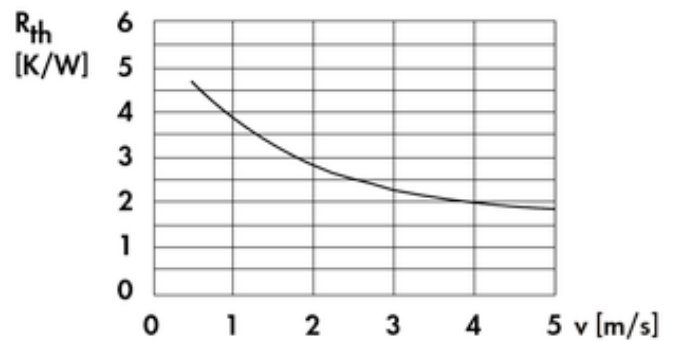
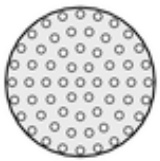
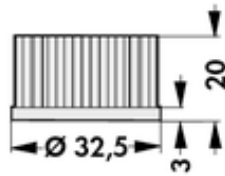
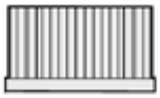
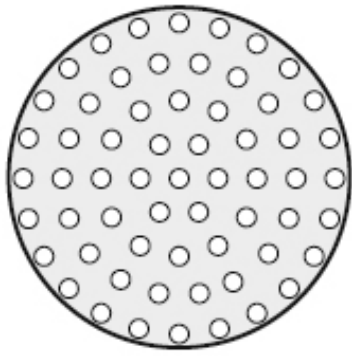


Pin heatsinks / **ICK S R 32,5 x 20**

Ø 32,5 x 20 mm, pin heatsinks round

**Parameters of article ICK S R 32,5 x 20**

|                                    |  |
|------------------------------------|--|
| <b>Bauform</b>                     | Rund   |
| <b>R<sub>th</sub> [K/W]</b>        | 5.6  |
| <b>dissipation loss [W]</b>        | 8.9  |
| <b>mounting method</b>             | therm. conductive foil / therm. cond. adhesive |
| <b>socket</b>                      | universal                                      |
| <b>suitable for processor type</b> | universal                                      |
| <b>Ø [mm]</b>                      | 32.5   |
| <b>height [mm]</b>                 | 20   |
| <b>plate thickness [mm]</b>        | 3  |
| <b>weight [g]</b>                  | 13.8   |

**Accessories/ related articles**

Thermally conductive foil both sides adhesive / **WLFT 404 D 32**

Thermally conductive foil both sides adhesive / **WLFT 405 D 32**